

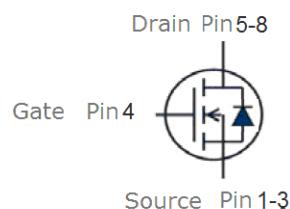
Features

- N-Channel, 5V Logic Level Control
- Enhancement mode
- Very low on-resistance $R_{DS(on)}$ @ $V_{GS}=4.5$ V
- VitoMOS® Technology
- 100% Avalanche test
- Pb-free lead plating; RoHS compliant



V_{DS}	80	V
$R_{DS(on),TYP}$ @ $V_{GS}=10$ V	8	$m\Omega$
$R_{DS(on),TYP}$ @ $V_{GS}=4.5$ V	9	$m\Omega$
I_D	65	A

PDFN5x6



Part ID	Package Type	Marking	Tape and reel information
VSP007N07MS	PDFN5x6	007N07M	3000PCS/Reel

Maximum ratings, at $T_j=25^\circ C$, unless otherwise specified

Symbol	Parameter	Rating	Unit
$V_{(BR)DSS}$	Drain-Source breakdown voltage	80	V
I_s	Diode continuous forward current	$T_c=25^\circ C$	A
I_D	Continuous drain current@ $V_{GS}=10V$	$T_c=25^\circ C$	A
		$T_c=100^\circ C$	A
I_{DM}	Pulse drain current tested ①	$T_c=25^\circ C$	A
EAS	Avalanche energy, single pulsed ②	$I_D=15A$	mJ
P_D	Maximum power dissipation	$T_c=25^\circ C$	W
V_{GS}	Gate-Source voltage	± 20	V
$T_{STG} T_J$	Storage and operating temperature range	-55 to 175	°C

Thermal Characteristics

Symbol	Parameter	Typical	Unit
$R_{\theta JC}$	Thermal Resistance-Junction to Case	2.5	°C/W
$R_{\theta JA}$	Thermal Resistance Junction-Ambient	60	°C/W

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
Static Electrical Characteristics @ T_c = 25°C (unless otherwise stated)						
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	80	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current(T _c =25 °C)	V _{DS} =64V, V _{GS} =0V	--	--	0.1	μA
	Zero Gate Voltage Drain Current(T _c =125 °C)	V _{DS} =64V, V _{GS} =0V	--	--	100	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V	--	--	±100	nA
V _{GS(TH)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	1.0	2.0	3.0	V
R _{DS(ON)}	Drain-Source On-State Resistance ^③	V _{GS} =10V, I _D =20A	--	8	10	mΩ
R _{DS(ON)}	Drain-Source On-State Resistance ^③	V _{GS} =4.5V, I _D =10A	--	9	11	mΩ
Dynamic Electrical Characteristics @ T_c = 25°C (unless otherwise stated)						
C _{iss}	Input Capacitance	V _{DS} =30V, V _{GS} =0V, f=1MHz	--	3000	--	pF
C _{oss}	Output Capacitance		--	250	--	pF
C _{rss}	Reverse Transfer Capacitance		--	205	--	pF
R _g	Gate Resistance	f=1MHz	--	1.5	--	Ω
Q _g	Total Gate Charge	V _{DS} =30V, I _D =30A, V _{GS} =10V	--	78	--	nC
Q _{gs}	Gate-Source Charge		--	19	--	nC
Q _{gd}	Gate-Drain Charge		--	10	--	nC
Switching Characteristics						
t _{d(on)}	Turn-on Delay Time	V _{DD} =30V, I _D =10A, R _G =6.8Ω, V _{GS} =10V	--	13	--	nS
t _r	Turn-on Rise Time		--	25	--	nS
t _{d(off)}	Turn-Off Delay Time		--	98	--	nS
t _f	Turn-Off Fall Time		--	43	--	nS
Source- Drain Diode Characteristics@ T_c = 25°C (unless otherwise stated)						
V _{SD}	Forward on voltage	I _{SD} =20A, V _{GS} =0V	--	0.78	1.2	V
t _{rr}	Reverse Recovery Time	T _j =25 °C, I _{sd} =20A, V _{GS} =0V di/dt=200A/μs	--	25	--	nS
Q _{rr}	Reverse Recovery Charge		--	47	--	nC

NOTE:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Limited by T_{Jmax}, starting T_J = 25°C, L = 0.5mH, R_G = 25Ω, I_{AS} = 15A, V_{GS} = 10V. Part not recommended for use above this value
- ③ Pulse width ≤ 300μs; duty cycle≤ 2%.



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VSP007N07MS

80V/65A N-Channel Advanced Power MOSFET

Typical Characteristics

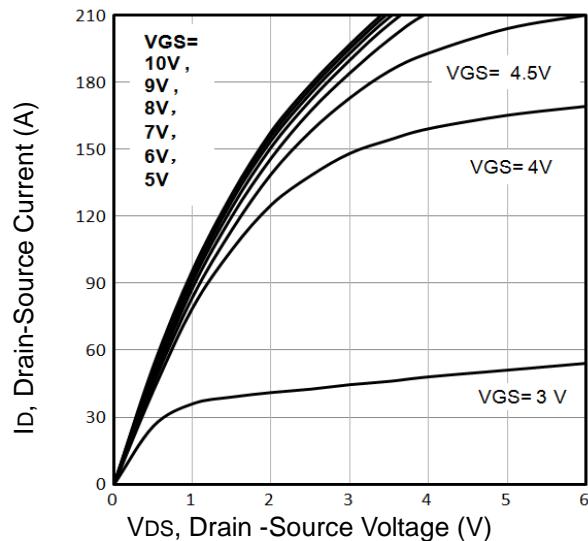


Fig1. Typical Output Characteristics

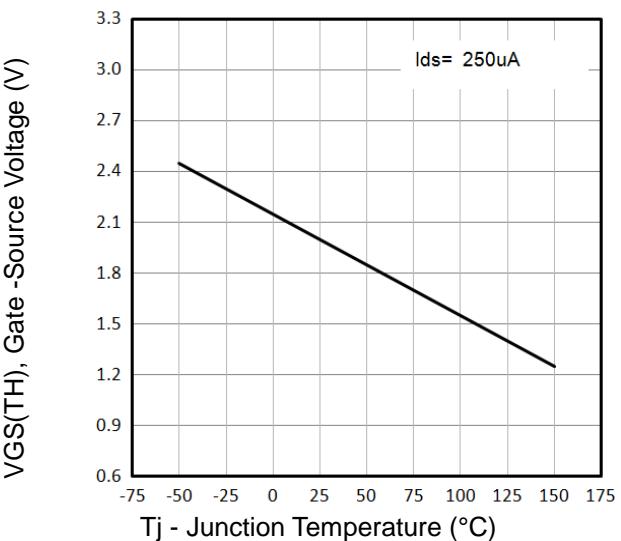


Fig2. Normalized Threshold Voltage Vs. Temperature

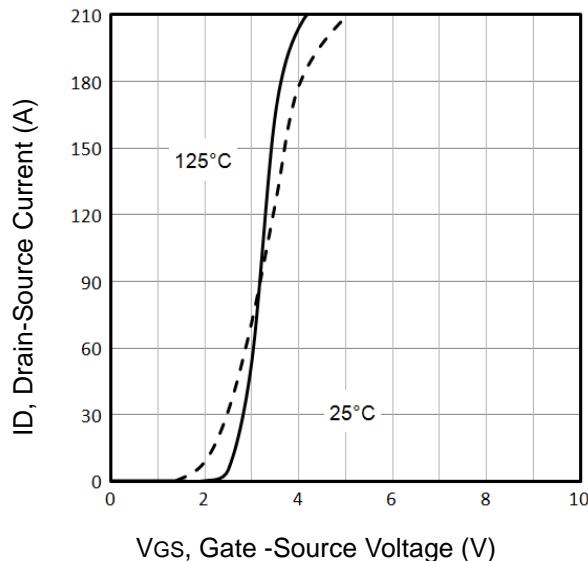


Fig3. Typical Transfer Characteristics

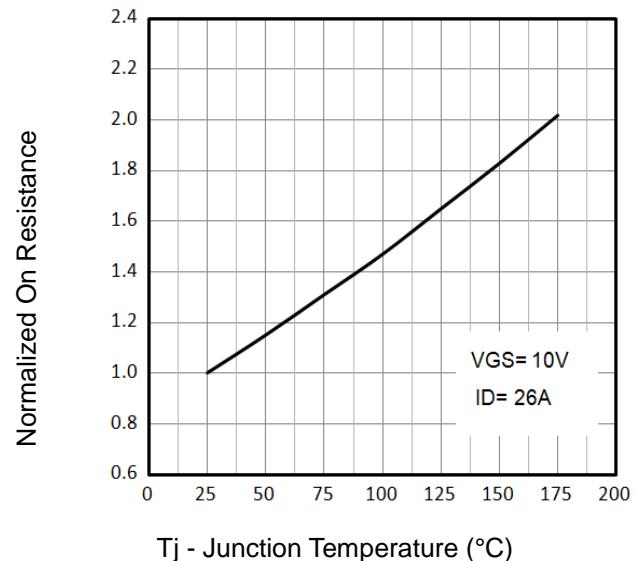


Fig4. Normalized On-Resistance Vs. Temperature

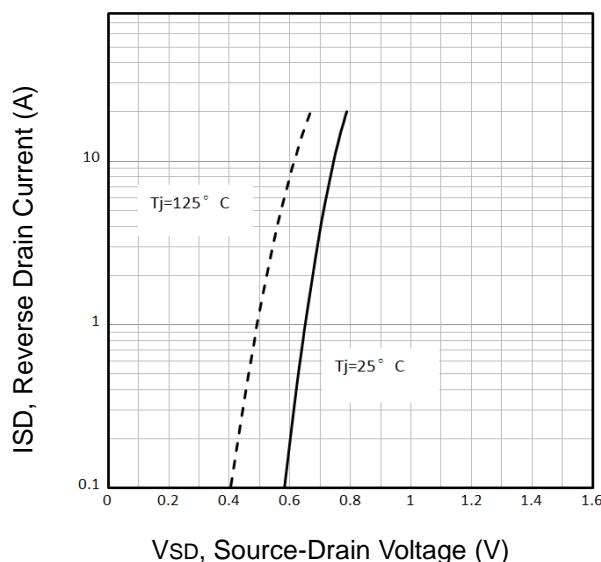


Fig5. Typical Source-Drain Diode Forward Voltage

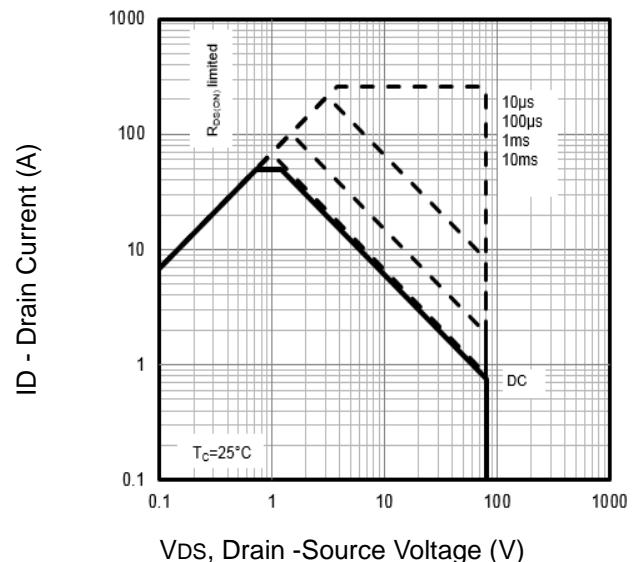


Fig6. Maximum Safe Operating Area

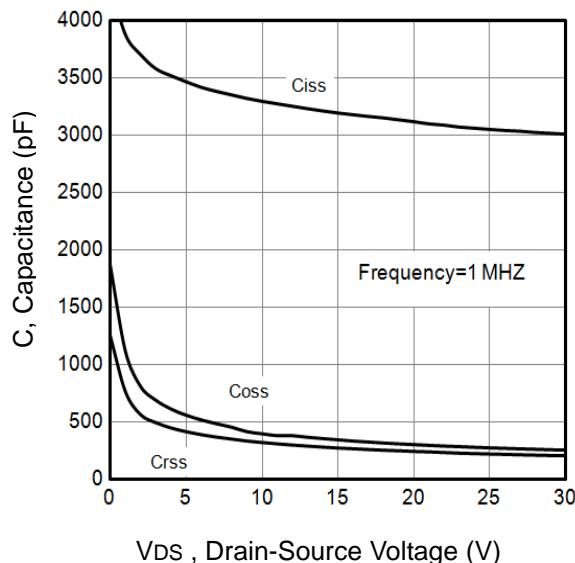


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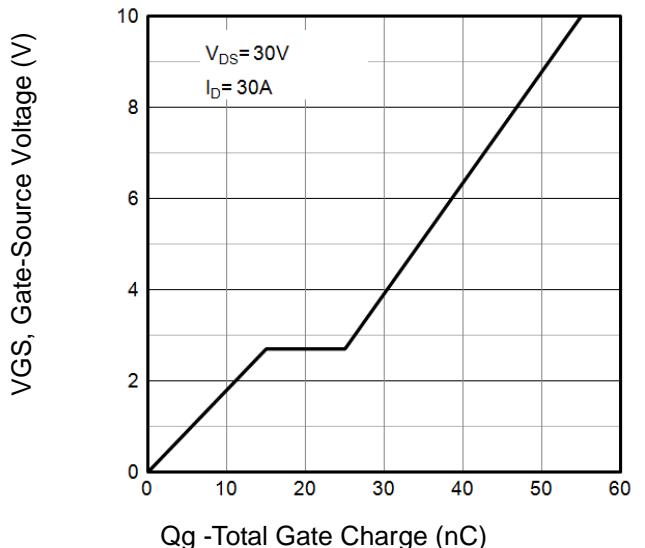
80V/65A N-Channel Advanced Power MOSFET

Typical Characteristics



V_{DS} , Drain-Source Voltage (V)

Fig7. Typical Capacitance Vs.Drain-Source



V_{Gs} , Gate-Source Voltage (V)

Fig8. Typical Gate Charge Vs.Gate-Source

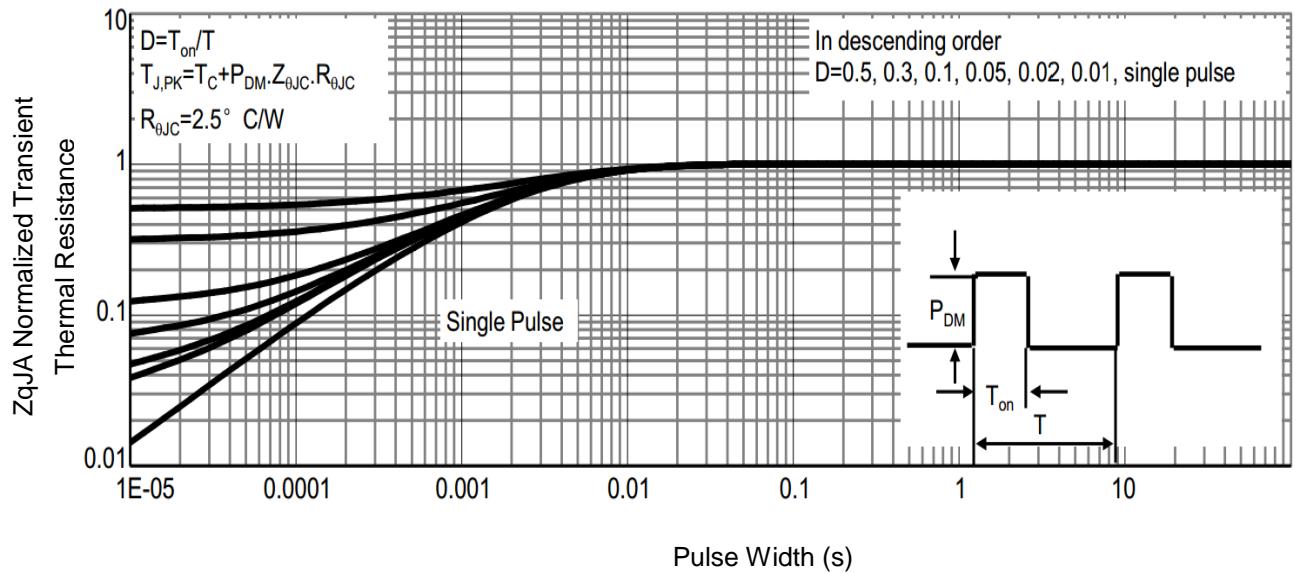


Fig9. Normalized Maximum Transient Thermal

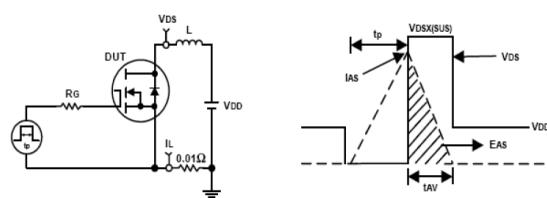


Fig10. Unclamped Inductive Test Circuit and waveforms

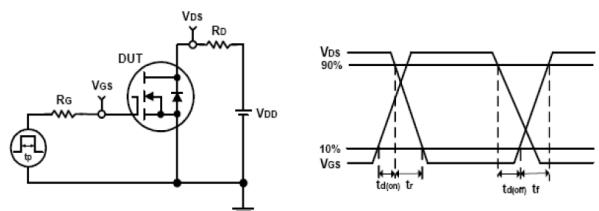
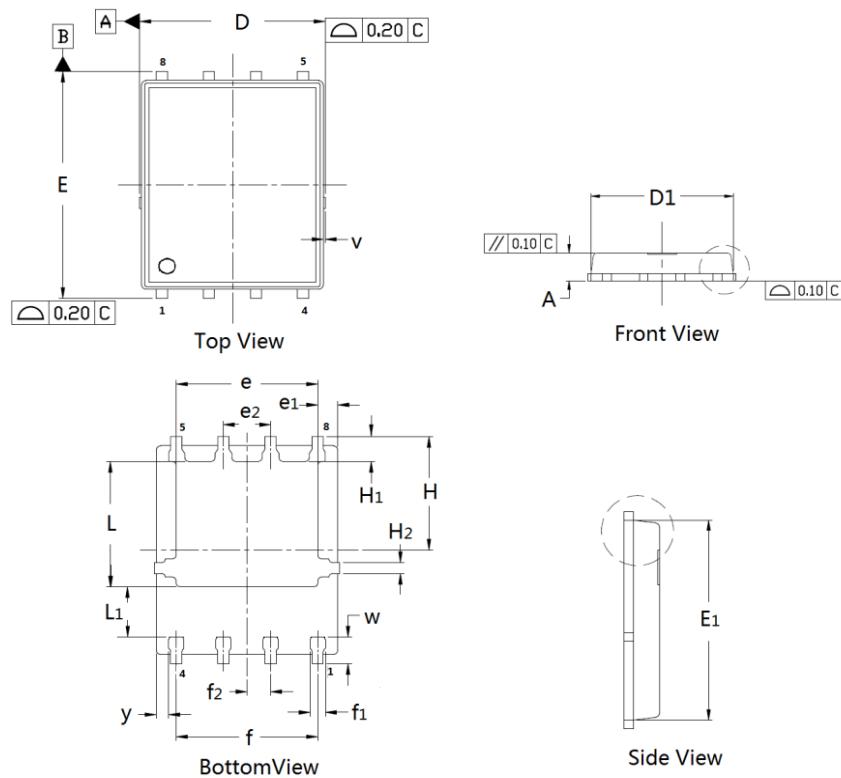


Fig11. Switching Time Test Circuit and waveforms



PDFN5×6 Package Outline Data



DIMENSIONS (unit : mm)

Symbol	Min	Typ	Max	Symbol	Min	Typ	Max
A	0.90	1.02	1.10	D	4.90	4.98	5.10
D ₁	4.80	4.89	5.00	E	6.00	6.11	6.20
E ₁	5.65	5.74	5.85	e	3.72	3.80	3.92
e ₁	--	0.54	--	e ₂	--	1.27	--
f	--	3.82	--	f ₁	0.31	0.37	0.51
f ₂	--	0.64	--	H	--	3.15	--
H ₁	0.59	0.63	0.79	H ₂	0.26	0.28	0.32
L	3.38	3.45	3.58	L ₁	--	1.39	--
v	--	0.13	--	w	0.64	0.68	0.84
y	--	0.34	--		--	--	--

Customer Service

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